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U.S. UTILITY Patent Application

PATENT NUMBER and  
ISSUE DATE

75.9

APPL NUM 10066245	FILING DATE 01/31/2002	CLASS 271	SUBCLASS 271.1	GAU 11324	EXAMINER ORTIZ
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\*\*APPLICANTS: Siegel Harry; Chiu Anthony;

\*\*CONTINUING DATA VERIFIED: NONE

\*\* FOREIGN APPLICATIONS VERIFIED: NONE

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	ATTORNEY DOCKET NO
35 USC 119 conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	01-C-084 (STMI01-01084)
Verified and Acknowledged Examiners's initials <i>QDZ RD</i>		
TITLE : System and method for using a pre-formed film in a transfer molding process for an integrated circuit		

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Primary Examiner PREPARED FOR ISSUE Application Examiner	
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